

Description

Features

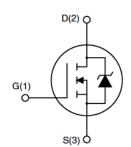
- 800V, 10A
- \bullet R_{DS(ON)} =0.8 Ω (Typ.) @ V_{GS} = 10V, I_D =5A
- Fast Switching
- 100% Avalanche Tested
- Improved dv/dt Capability

Application

- Switch Mode Power Supply (SMPS)
- Uninterruptible Power Supply (UPS)
- Power Factor Correction (PFC)







Schematic Diagram

Absolute Maximum Ratings (T_C=25 ℃ unless otherwise specified)

Cumbal	Parameter		Ma	Unito	
Symbol			TO-220F	TO-247	Units
V_{DSS}	Drain-Source Voltage		800		V
Vgss	Gate-Source Voltage		±3	V	
ΙD	Continuous Drain Current	T _C = 25°C	1	А	
		T _C = 100°C	6		А
I _{DM}	Pulsed Drain Current note1		4	А	
Eas	Single Pulsed Avalanche Energy note2		562		mJ
P _D	Power Dissipation	T _C = 25°C	65	260	W
Rejc	Thermal Resistance, Junction to Case		1.92	0.48	°C/W
R _{θJA}	Thermal Resistance, Junction to Ambient		62.5	41	°C/W
T _J , T _{STG}	Operating and Storage Temperature Range		-55 to	$^{\circ}\mathbb{C}$	



Electrical Characteristics ($T_C=25^{\circ}C$ unless otherwise specified)

Symbol	Parameter	Test Condition	Min.	Тур.	Max.	Units				
Off Characteristic										
V _{(BR)DSS}	Drain-Source Breakdown Voltage	$V_{GS} = 0V, I_D = 250 \mu A$	800	-	-	V				
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = 800V,		-	1	μА				
		V _{GS} = 0V, T _J = 25°C	-							
		V _{DS} = 640V,			100					
		V _{GS} = 0V, T _J = 125°C	'		100					
Igss	Gate to Body Leakage Current	V _{GS} = ±30V	-	-	±100	nA				
On Charac	cteristics									
V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	2.0	3.0	4.0	V				
R _{DS(on)}	Static Drain-Source On-Resistance	V _{GS} =10V, I _D = 5A	-	0.8	1	Ω				
Dynamic 0	Characteristics	<u> </u>								
Ciss	Input Capacitance), or, , , , , , , , , , , , , , , , , ,	-	1979	-	pF				
Coss	Output Capacitance	$V_{DS} = 25V, V_{GS} = 0V,$	-	233	-	pF				
Crss	Reverse Transfer Capacitance	f = 1.0MHz	-	53	-	pF				
Qg	Total Gate Charge	\/ 040\/ L 40A	-	83	-	nC				
Q _{gs}	Gate-Source Charge	$V_{DD} = 640V, I_{D} = 10A,$	-	9	-	nC				
Q _{gd}	Gate-Drain("Miller") Charge	V _{GS} = 10V	-	49	-	nC				
Switching	Characteristics									
t _{d(on)}	Turn-On Delay Time		-	23	-	ns				
t _r	Turn-On Rise Time	$V_{DD} = 400V, I_D = 10A,$	-	15	-	ns				
t _{d(off)}	Turn-Off Delay Time	$R_G = 25\Omega$	-	90	-	ns				
t _f	Turn-Off Fall Time		-	30	-	ns				
Drain-Sou	rce Diode Characteristics and Maxir	num Ratings								
ls	Maximum Continuous Drain to Source Diode Forward				10	۸				
	Current				10	Α				
Ism	Maximum Pulsed Drain to Source Diode Forward Current			-	40	Α				
V _{SD}	Drain to Source Diode Forward	$V_{GS} = 0V$, $I_{SD} = 10A$,	-	-	1.4	V				
	Voltage	T _J = 25℃								
t _{rr}	Reverse Recovery Time	$V_{GS} = 0V, I_{S} = 10A,$	-	320	-	ns				
Qrr	Reverse Recovery Charge	di/dt =100A/µs	-	4.2	-	uC				

Notes: 1. Repetitive Rating: Pulse width limited by maximum junction temperature

- 2. I_{AS} = 7.5A, V_{DD} = 50V, Starting T_J = 25°C
- 3. Pulse Test: Pulse Width≤300µs, Duty Cycle≤1%



Typical Performance Characteristics

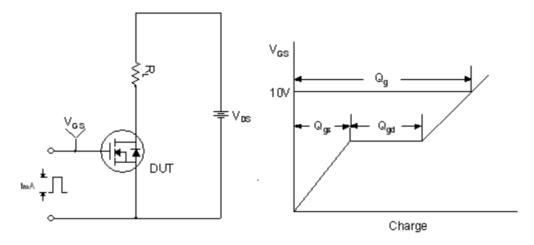


Figure 1. Gate Charge Test Circuit & Waveform

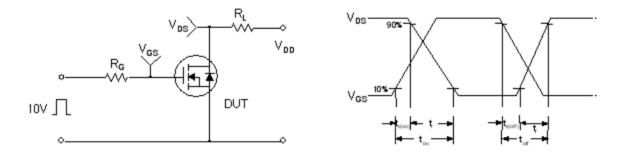


Figure 2. Resistive Switching Test Circuit & Waveforms

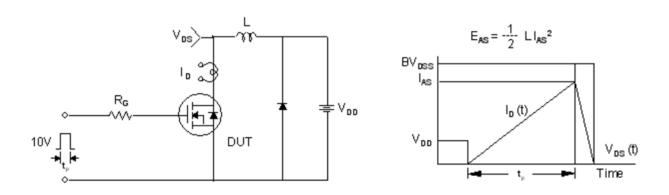
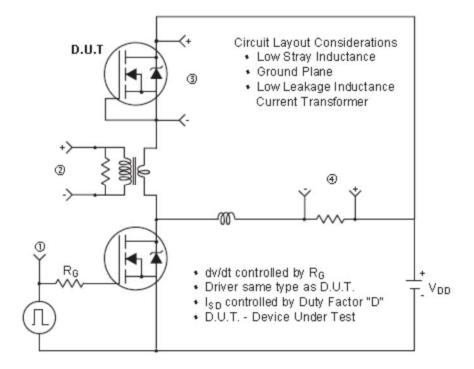


Figure 3. Unclamped Inductive Switching Test Circuit & Waveforms





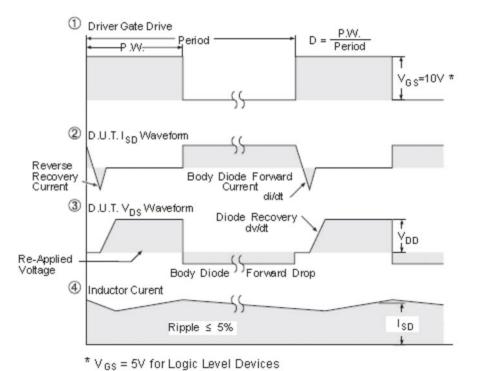


Figure 4. Peak Diode Recovery dv/dt Test Circuit & Waveforms (For N-channel)